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Part Number:

0432028801

Status:

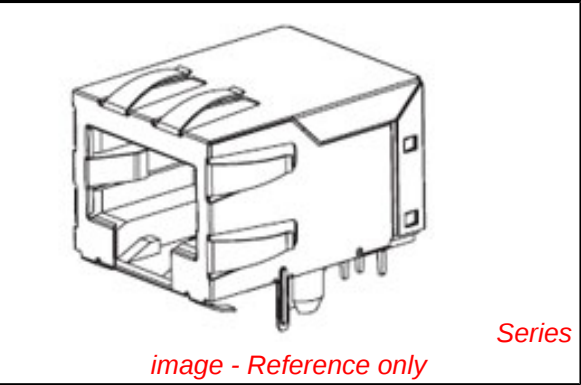
Active

Overview:

modular_plugs_jacks

Description:

Modular Jack, Right Angle, Low Profile, Shielded, Top Panel Grounding Tabs, without Bottom Grounding Tab, Front Position PCB Ground Tab, 8/10



Documents:

3D Model

Drawing (PDF)

Product Specification PS-43202-001 (PDF)

RoHS Certificate of Compliance (PDF)

Agency Certification	
CSA	LR19980
UL	E107635
General	
Product Family	Modular Jacks/Plugs
Series	43202
Component Type	PCB Jack
Magnetic	No
Overview	modular_plugs_jacks
Performance Category	3
Power over Ethernet (PoE)	N/A
Product Name	RJ45
Physical	
Color - Resin	Black
Durability (mating cycles max)	500
Flammability	94V-0
Inverted / Top Latch	No
Lightpipes/LEDs	None
Material - Metal	Brass, Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Orientation	Right Angle (Side Entry)
PCB Retention	Yes
PCB Thickness Recommended (in)	0.062 In
PCB Thickness Recommended (mm)	1.60 mm
Packaging Type	Tray
Panel Mount	With Flange
Pitch - Mating Interface (in)	0.050 In
Pitch - Mating Interface (mm)	1.27 mm
Plating min: Mating (µin)	50
Plating min: Mating (µm)	1.25
Plating min: Termination (µin)	100
Plating min: Termination (µm)	2.5
Ports	1
Positions / Loaded Contacts	8/10
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-40°C to +85°C
Termination Interface: Style	Through Hole
Wire/Cable Type	N/A
Electrical	
Current - Maximum per Contact	1.5A
Grounding to PCB	Yes

EU RoHS

ELV and RoHS

Compliant

REACH SVHC

Not Reviewed

Halogen-Free

Status

Not Reviewed

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com

For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

43202Series

Mates With

FCC 68 Plugs

Grounding to Panel	Top Panel Ground Tabs
Shielded	Yes
Voltage - Maximum	125V

Solder Process Data

Lead-free Process Capability	Wave Capable (TH only)
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Material Info

Reference - Drawing Numbers

Packaging Specification	PK-43202-004
Product Specification	PS-43202-001, RPS-43202-002
Sales Drawing	SDA-43202

This document was generated on 06/07/2010

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NOTES:

1) MATERIAL:

HOUSING: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: SEE SHEETS 5 AND 6
INSULATOR: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: SEE SHEETS 5 AND 6
TERMINALS: PHOSPHOR BRONZE, .012/ 0.30 THICK
SHIELD: BRASS, .007/ 0.18 THICK

2) FINISH:

TERMINALS:

A = SELECT GOLD IN CONTACT AREA: 50 MICROINCHES / 1.27 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
B = SELECT GOLD IN CONTACT AREA: 30 MICROINCHES / 0.76 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAILS AND/OR SHIELD.

SHIELD:

100 MICROINCHES / 2.54 MICROMETERS NICKEL OVER 50 MICROINCHES / 1.27
MICROMETERS COPPER UNDERPLATE PCB GROUND TABS DIPPED IN TIN

3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43202.

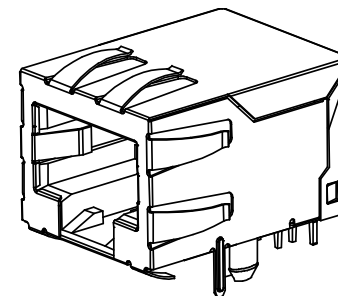
4) PACKAGING SPECIFICATION:

UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43202-003.
UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN TUBES
PER MOLEX PACKAGING SPECIFICATION PK-43202-005.
SHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43202-004.

5) SEE SHEETS 7 - 9 FOR P.C. BOARD LAYOUTS.

6) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.

7) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.



SHIELDED MODULAR JACK
SHOWN WITH PANEL GROUND
OPTION 'D' AND FRONT
PCB GROUND TABS.

DRAWING LEGEND

SHEET 1- NOTES, DRAWING LEGEND
SHEET 2- SHIELDED MODULAR JACK W/ BOTTOM GROUND TABS
SHEET 3- SHIELDED MODULAR JACK W/O BOTTOM GROUND TABS
SHEET 4- UNSHIELDED MODULAR JACK
SHEET 5- PART NUMBER CHARTS
SHEET 6- PART NUMBER CHARTS
SHEET 7- FOOTPRINT LAYOUT FOR 4 POSITION HOUSING
SHEET 8- FOOTPRINT LAYOUT FOR 6 POSITION HOUSING
SHEET 9- FOOTPRINT LAYOUT FOR 8 POSITION HOUSING

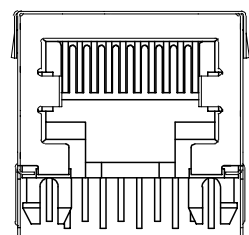
OBS COLORED JACKS EC NO: UCP2008-1189 DRAWN:JBELL 2007/11/30 CHKD:LSCHMIDT 2008/02/20 APPR:FSM/TH 2008/03/04	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION	
				mm	INCH	DRAWN BY	DATE	TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY MOLEX INCORPORATED	DOCUMENT NO.	SHEET NO. 1 OF 9	
				4 PLACES ± --- ± ---	JTR	1993/03/31					
				3 PLACES ± --- ± .010	CHECKED BY	DATE					
				2 PLACES ± 0.25 ± .014	JTR	1993/03/31					
				1 PLACE ± 0.36 ± ---	APPROVED BY	DATE					
				ANGULAR ±1/2°		RAS	1993/03/31	MATERIAL NO. SEE SHTS 5&6	SDA-43202		
				DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE				THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	

9	L2
8	L2
7	L2
6	L4
5	L
4	K2
3	L1
2	L1
1	L4
SH	REV

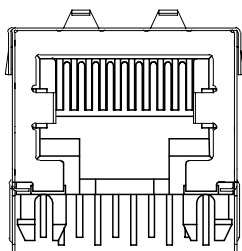
SHIELDED MODULAR JACK W/O BOTTOM GROUND TABS

SIZE 8, LOADED 10 VERSION SHOWN

SIDE/TOP GROUND TAB OPTIONS FOR SHIELDS



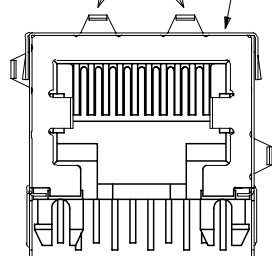
OPTION "E"
NO TOP OR SIDE TABS



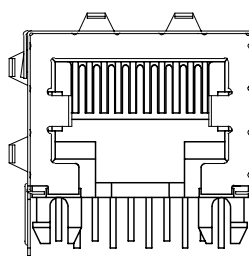
OPTION "F"
TOP TABS

OPTIONAL TOP GROUND TABS

SHIELDED MODULAR JACK ASSEMBLY
SEE SHEET 6 FOR MATERIAL NO.

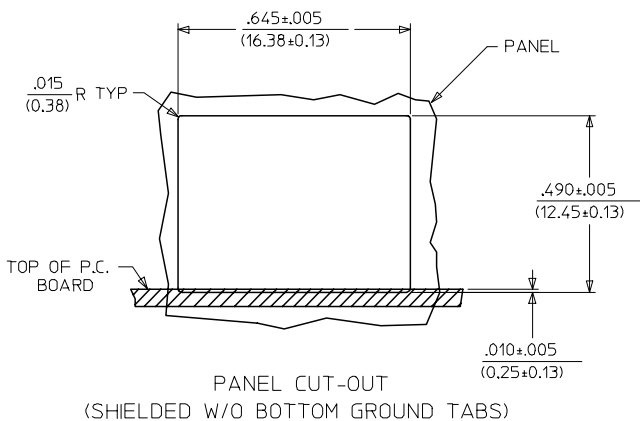


OPTION "G"
TOP AND STAGGERED SIDE TABS

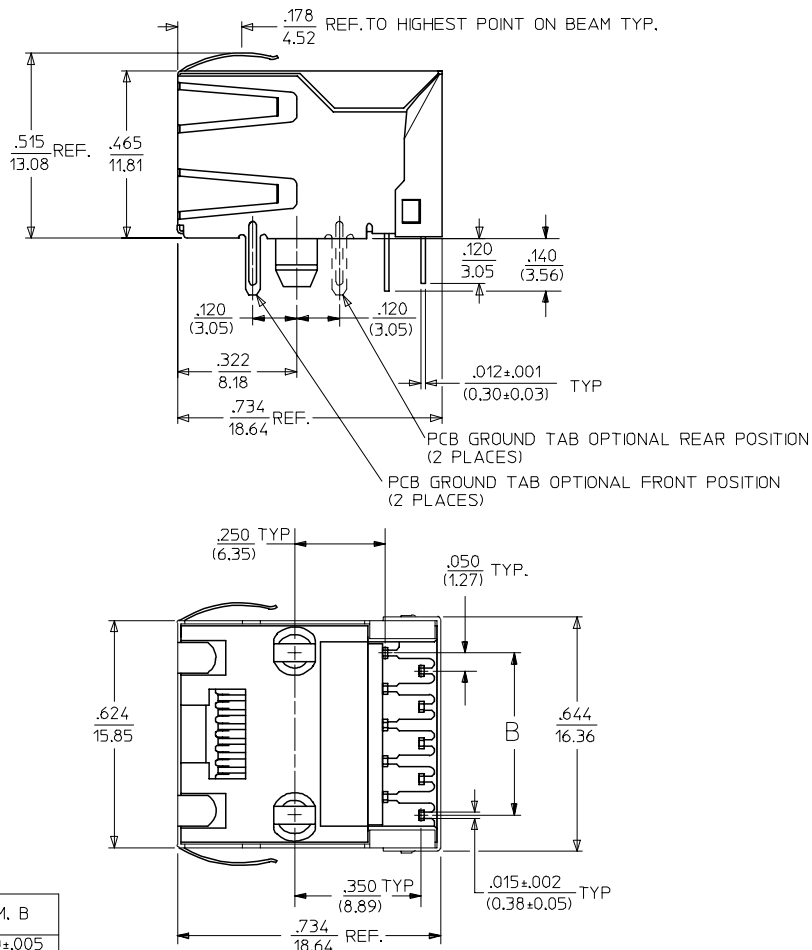


OPTION "H"
TOP AND SIDE TABS

OPTIONAL SIDE
GROUND TABS
(2 PLACES)

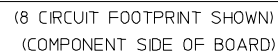


HOUSING SIZE	CIRCUIT SIZE	DIM. B
8	10	.450±.005 (11.43±.13)
8	8	.350±.005 (8.89±.13)



SEE SHEET ONE EC NO: UCP2004-1888 DRAWN: SCHMIDT 2004/03/31 CHKD: SCHMIDT 2004/03/31 APPR: FSMITH 2004/03/31 REV L1	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)			SCALE 4:1	DESIGN UNITS INCH	THIRD ANGLE PROJECTION		REVISE ON CAD ONLY				
						DIMENSION STYLE		TITLE						
						IN/MM		ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY						
			4 PLACES ± --- ± ---			DRAWN BY JTR							DATE 1993/03/31	
			3 PLACES ± --- ± .010			CHECKED BY JTR							DATE 1993/03/31	
			2 PLACES ± 0.25 ± .014			APPROVED BY RAS							DATE 1993/03/31	
			1 PLACE ± 0.36 ± ---			MATERIAL NO.		DOCUMENT NO.		SHEET NO.				
			ANGULAR ±1/2°			SEE SHT 6		SDA-43202		3 OF 9				
			DRAFT WHERE APPLICABLE			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								
			MUST REMAIN WITHIN DIMENSIONS			C								

	13	12	11	10	9	8	7	6	5	4	3	2	1			
J	SHIELDED MODULAR JACKS W/O BOTTOM GROUND TABS (SHEET 3)							UNSHIELDED MODULAR JACKS- (SHEET 4)							J	
	ASSEMBLY MATERIAL NUMBER	CONNECTOR SIZE	NUMBER OF CIRCUITS	SIDE/TOP PANEL GROUND TAB OPTION	PCB GROUND TAB OPTION	TERMINAL PLATING OPTION	PACKAGING	HOUSING COLOR	ASSEMBLY MATERIAL NUMBER	CONNECTOR SIZE	NUMBER OF CIRCUITS	TERMINAL PLATING OPTION	KEYING OPTION	PACKAGING OPTION	HOUSING COLOR	
I	43202-8800	8	10	E	FRONT POSITION	A	TRAY	BLACK	43202-4101	4	4	A	NO	TRAY	BLACK	I
	43202-8801	8	10	F	FRONT POSITION	A	TRAY		43202-4104	4	2	A	NO	TRAY		
	43202-8802	8	10	G	FRONT POSITION	A	TRAY		43202-6101	6	6	A	NO	TRAY		
	43202-8803	8	10	H	FRONT POSITION	A	TRAY		43202-6102	6	6	B	NO	TRAY		
	43202-8808	8	10	E	REAR POSITION	A	TRAY		43202-6104	6	4	A	NO	TRAY		
	43202-8809	8	10	F	REAR POSITION	A	TRAY		43202-6105	6	4	B	NO	TRAY		
	43202-8810	8	10	G	REAR POSITION	A	TRAY		43202-6107	6	2	A	NO	TRAY		
H	43202-8811	8	10	H	REAR POSITION	A	TRAY		43202-6110	6	6	B	NO	TUBE		
	43202-8816	8	8	E	FRONT POSITION	A	TRAY		43202-8101	8	10	A	NO	TRAY		H
	43202-8817	8	8	F	FRONT POSITION	A	TRAY		43202-8104	8	8	A	NO	TRAY		
	43202-8818	8	8	G	FRONT POSITION	A	TRAY		43202-8105	8	8	B	NO	TRAY		
	43202-8819	8	8	H	FRONT POSITION	A	TRAY		43202-8113	8	8	A	YES	TRAY		
	43202-8824	8	8	E	REAR POSITION	A	TRAY		43202-8116	8	6	A	NO	TRAY		
	43202-8825	8	8	F	REAR POSITION	A	TRAY		43202-8119	8	4	A	NO	TRAY		
G	43202-8826	8	8	G	REAR POSITION	A	TRAY		43202-8122	8	2	A	NO	TRAY		
	43202-8827	8	8	H	REAR POSITION	A	TRAY		43202-8504	8	8	A	NO	TUBE		G
									43202-8513	8	8	A	YES	TUBE		
F																F
E																E
D																D
C																C
B																B
A																A



NOTES:
1. RECOMMENDED PCB THICKNESS: .062±.005/(1.57±0.13)

ADD PCB THICKNESS

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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